# MOS FIELD EFFECT TRANSISTOR 2SK2353/2SK2354

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

# DESCRIPTION

NEC

The 2SK2353/2SK2354 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

# FEATURES

- Low On-Resistance
  2SK2353: R<sub>DS(on)</sub> = 1.4 Ω (V<sub>GS</sub> = 10 V, I<sub>D</sub> = 2.5 A)
  2SK2354: R<sub>DS(on)</sub> = 1.5 Ω (V<sub>GS</sub> = 10 V, I<sub>D</sub> = 2.5 A)
- Low C<sub>iss</sub> C<sub>iss</sub> = 670 pF TYP.
- High Avalanche Capability Ratings
- Isolate TO-220 Package

# QUALITY GRADE

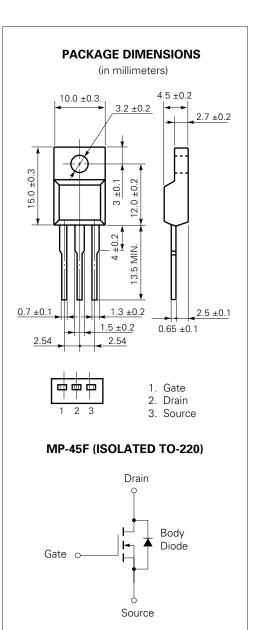
#### Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (2SK2353/2354)	Vdss	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	D(DC)	±4.5	А
Drain Current (pulse)*	D(pulse)	) ±18	А
Total Power Dissipation (T <sub>c</sub> = 25 $^{\circ}$ C)	P⊤1	30	W
Total Power Dissipation ( $T_a = 25$ °C)	<b>Р</b> т2	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg -	-55 to +150	°C
Single Avalanche Current**	las	4.5	А
Single Avalanche Energy**	Eas	17.4	mJ

- \* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %
- \*\* Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0



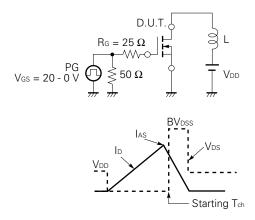
The information in this document is subject to change without notice.

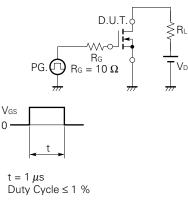
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

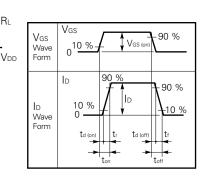
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-Resistance	RDS(on)		1.0	1.4	Ω	$V_{GS} = 10 V$	2SK2353
			1.1	1.5		ID = 2.5 A	2SK2354
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	2.5		3.5	V	Vds = 10 V, Id = 1 mA	
Forward Transfer Admittance	y <sub>fs</sub>	1.0			S	Vds = 10 V, Id = 2.5 A	
Drain Leakage Current	IDSS			100	μΑ	Vds = Vdss, Vgs = 0	
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$	
Input Capacitance	Ciss		670		pF	$V_{DS} = 10 V$	
Output Capacitance	Coss		140		pF	V <sub>GS</sub> = 0	
Reverse Transfer Capacitance	Crss		18		pF	f = 1 MHz	
Turn-On Delay Time	td(on)		11		ns	ID = 2.5 A	
Rise Time	tr		8		ns	$V_{GS(on)} = 10 V$	
Turn-Off Delay Time	td(off)		40		ns	Vdd = 150 V	
Fall Time	tr		8		ns	$R_G$ = 10 $\Omega$ $R_L$ = 60 $\Omega$	
Total Gate Charge	QG		20		nC	ID = 4.5 A	
Gate to Source Charge	Q <sub>GS</sub>		4.5		nC	$V_{DD} = 400 V$	
Gate to Drain Charge	Qgd		9		nC	Vgs = 10 V	
Body Diode Forward Voltage	V <sub>F(S-D)</sub>		1.0		V	IF = 4.5 A, VGS = 0	
Reverse Recovery Time	trr		270		ns	IF = 4.5 A, Vo	as = 0
Reverse Recovery Charge	Qrr		1.0		nC	di/dt = 50 A/	μs

#### Test Circuit 1 Avalanche Capability

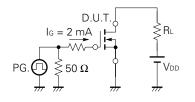
#### Test Circuit 2 Switching Time



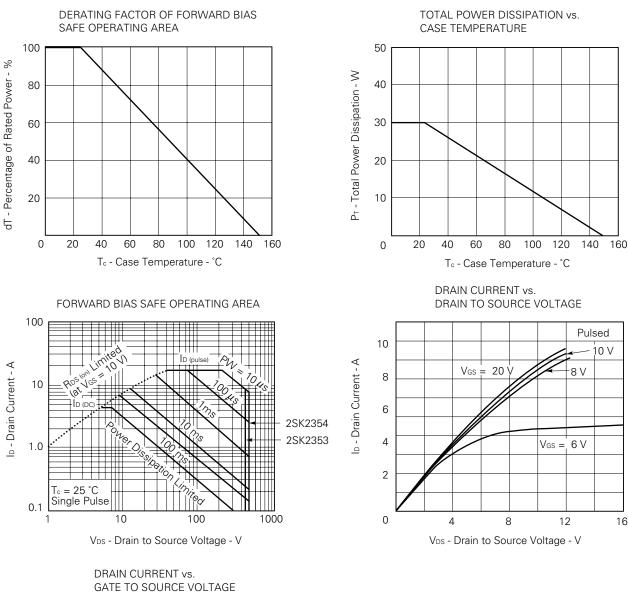




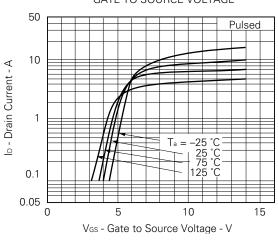
#### Test Circuit 3 Gate Charge



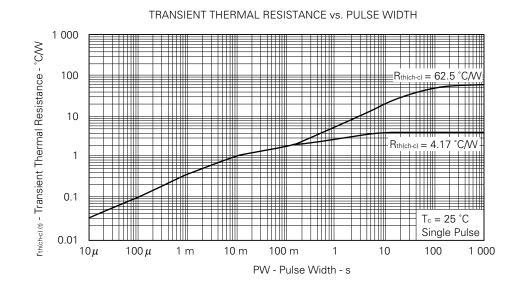
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.



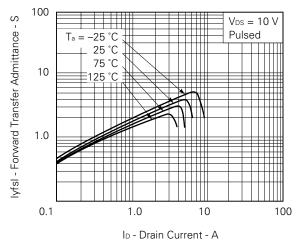
# TYPICAL CHARACTERISTICS (TA = 25 °C)

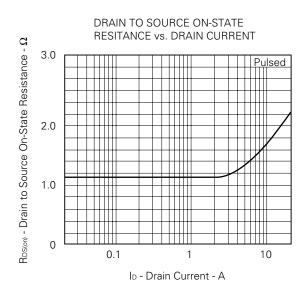


16

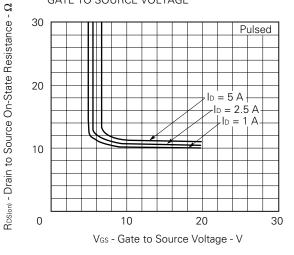




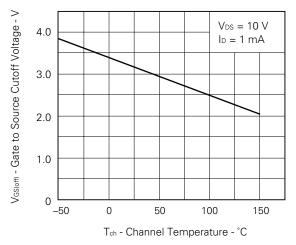


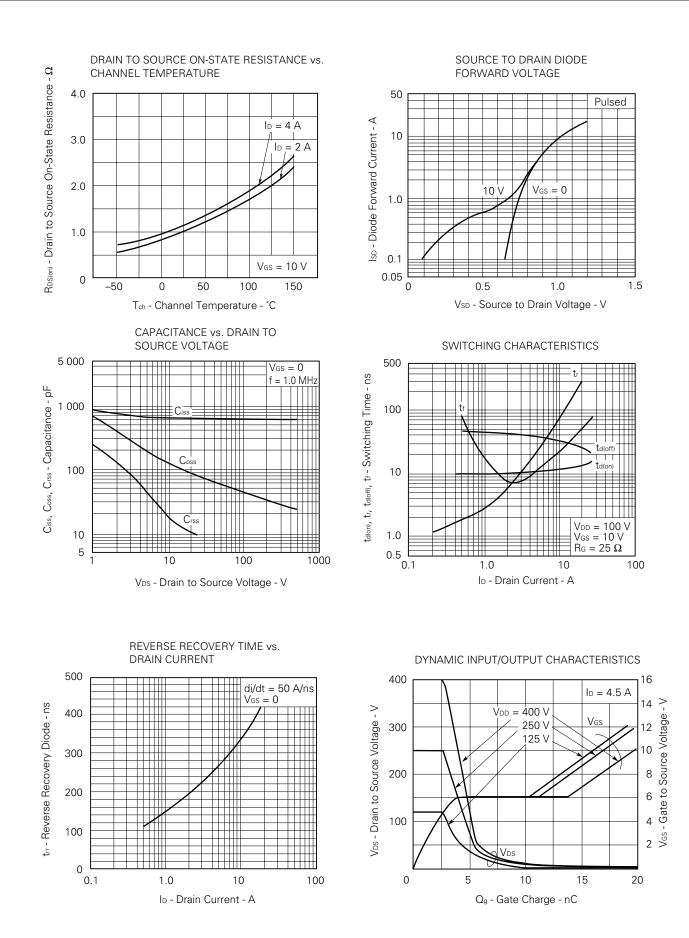


DRAIM TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

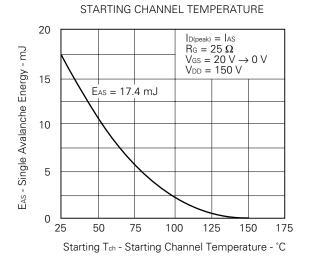




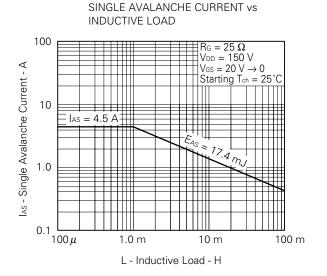




NEC



SINGLE AVALANCHE ENERGY vs



### REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.

NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from use of a device described herein or any other liability arising from use of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Corporation or others.

The devices listed in this document are not suitable for use in aerospace equipment, submarine cables, nuclear reactor control systems and life support systems. If customers intend to use NEC devices for above applications or they intend to use "Standard" quality grade NEC devices for applications not intended by NEC, please contact our sales people in advance.

Application examples recommended by NEC Corporation

Standard: Computer, Office equipment, Communication equipment, Test and Measurement equipment, Machine tools, Industrial robots, Audio and Visual equipment, Other consumer products, etc.

Special: Automotive and Transportation equipment, Traffic control systems, Antidisaster systems, Anticrime systems, etc.